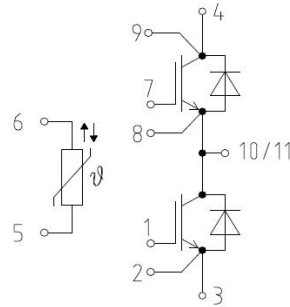
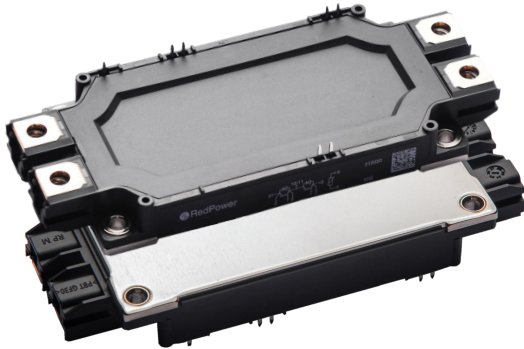


M series package: 1200V600A IGBT module

Datasheet



等效电路图

Equivalent Circuit Schematic

Features:

- 1200V 600A, $V_{CE(sat)} = 1.5\text{ V}@25^\circ\text{C}$
- MPT Gate Technology
- Low Losses
- High RBSOA capability
- Low reverse-recovery losses

产品特性:

- 1200V 600A, $V_{CE(sat)} = 1.5\text{ V}@25^\circ\text{C}$
- 微沟槽栅/场终止技术
- 低损耗
- 高 RBSOA 能力
- 低反向恢复损耗

Typical Applications:

- Motor Drives
- Solar Applications
- UPS Systems
- Energy Storage

典型应用:

- 电机驱动
- 光伏应用
- UPS 系统
- 储能

IGBT, Inverter / IGBT, 逆变部分
Maximum Rated Values / 最大标称参数

| | | | | |
|---|---|-----------|----------|---|
| Collector-Emitter Voltage 集电极-发射极电压 | $T_{vj}=25^{\circ}\text{C}$ | V_{CES} | 1200 | V |
| Continuous DC Collector Current 集电极连续直流电流 | $T_c=85^{\circ}\text{C}, T_{vjmax}\leq 175^{\circ}\text{C}$ | I_c | 600 | A |
| Repetitive Peak Collector Current 集电极可重复峰值电流 | $t_p=1\text{ms}$ | I_{CRM} | 1200 | A |
| Gate-Emitter Peak Voltage 门极-发射极峰值电压 | | V_{GES} | ± 20 | V |

Characteristic Values / 性能参数

| | | min. | typ. | max. | | |
|---|---|-------------|------------------------------|------------------------------|-----|---------------|
| Collector-Emitter Saturation Voltage ¹⁾ 集电极-发射极饱和压降 | $I_c=600\text{A}, V_{GE}=15\text{V}$ $T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$ | V_{CESat} | 1.40 1.50 1.77 1.79 | 1.70 | V | |
| Gate Threshold Voltage 门极阈值电压 | $V_{CE}=V_{GE}, I_c=24\text{mA}, T_{vj}=25^{\circ}\text{C}$ | V_{GEth} | 5.0 | 6.0 | 7.0 | V |
| Gate Charge 门极电荷 | $V_{GE}=-15\text{V}/15\text{V}, V_{CE}=600\text{V}$ | Q_G | - | 7.08 | - | μC |
| Internal Gate Resistor 内置门极电阻 | $T_{vj}=25^{\circ}\text{C}$ | R_{Gint} | - | 0.43 | - | Ω |
| Input Capacitance 输入电容 | $V_{CE}=25\text{V}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}, f=100\text{KHz}$ | C_{ies} | - | 128 | - | nF |
| Reverse Transfer Capacitance 反向传输电容 | $V_{CE}=25\text{V}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}, f=100\text{KHz}$ | C_{res} | - | 0.48 | - | nF |
| Collector-Emitter Cutoff Current 集电极-发射极关断漏电流 | $V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$ | I_{CES} | - | - | 0.1 | mA |
| Gate-Emitter Leakage Current 门极-发射极漏电流 | $V_{CE}=0\text{V}, V_{GE}=20\text{V}, T_{vj}=25^{\circ}\text{C}$ | I_{GES} | - | - | 500 | nA |
| Turn-on Delay Time, Inductive Load 开通延迟时间, 感性负载 | $I_c=600\text{A}, V_{CE}=600\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Gon}=0.5\Omega$ $T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$ | t_{don} | - | 250 255 260 251 | - | ns |
| Rise Time, Inductive Load 上升时间, 感性负载 | $I_c=600\text{A}, V_{CE}=600\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Gon}=0.5\Omega$ $T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$ | t_r | - | 79 95 95 93 | - | ns |
| Turn-off Delay Time, Inductive Load 关断延迟时间, 感性负载 | $I_c=600\text{A}, V_{CE}=600\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Goff}=3.6\Omega$ $T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$ | t_{doff} | - | 883 943 960 906 | - | ns |
| Fall Time, Inductive Load 下降时间, 感性负载 | $I_c=600\text{A}, V_{CE}=600\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Goff}=3.6\Omega$ $T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$ | t_f | - | 68 119 151 164 | - | ns |
| Turn-on Energy Loss Per Pulse 开通损耗 | $I_c=600\text{A}, V_{CE}=600\text{V}$ $V_{GE}=-8\text{V}/15\text{V}, L_{\sigma}=35\text{nH}$ $R_{Gon}=0.5\Omega$ $di/dt=5200\text{A}/\mu\text{s}(T_{vj}=175^{\circ}\text{C})$ $T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$ | E_{on} | - | 40.3 59.4 65.2 86.5 | - | mJ |

| | | | | | | | |
|--|--|---|-------------|-----|------------------------------|-----|-------------|
| Turn-off Energy Loss Per Pulse 关断损耗 | $I_C=600A, V_{GE}=600V$ $V_{GE}=-8V/15V, L_{\sigma}=35nH$ $R_{Goff}=3.6\Omega$ $dv/dt=5500V/\mu s(T_{vj}=175^{\circ}C)$ | $T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$ $T_{vj}=175^{\circ}C$ | E_{off} | - | 54.6 69.7 72.9 80.7 | - | mJ |
| SC Data 短路耐量 | $V_{GE}=-8V/15V$ $V_{CC}=600V$ | $t_p \leq 8\mu s, T_{vj}=150^{\circ}C$ $t_p \leq 6\mu s, T_{vj}=175^{\circ}C$ | I_{sc} | - | 3000 2600 | - | A |
| Thermal Resistance, Junction to Case 结-外壳热阻 | Per IGBT/单个 IGBT | | R_{thJC} | - | 0.051 | - | K/W |
| Thermal Resistance, Case to Heatsink 外壳-散热器热阻 | Per IGBT/单个 IGBT $\lambda_{grease} = 1W(m \cdot K)$ | | R_{thCH} | - | 0.019 | - | K/W |
| Temperature under switching conditions 工作温度 | | | $T_{vj op}$ | -40 | - | 175 | $^{\circ}C$ |

Diode, Inverter / 二极管, 逆变部分

Maximum Rated Values / 最大标称参数

| | | | | |
|--|------------------------|------------|------|---|
| Repetitive peak reverse voltage 可重复反向峰值电压 | $T_{vj}=25^{\circ}C$ | V_{RRM} | 1200 | V |
| Continuous DC Forward Current 可连续正向直流电流 | | I_{Fnom} | 600 | A |
| Repetitive Peak Forward Current 可重复正向峰值电流 | $I_{FRM}=2 \times I_F$ | I_{FRM} | 1200 | A |

Characteristic Values / 性能参数

| | | | min. | typ. | max. | | |
|--|---|---|-------------|------|------------------------------|------|-------------|
| Forward Voltage ²⁾ 正向通态压降 | $I_F=600A, V_{GE}=0V$ | $T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=175^{\circ}C$ | V_F | 1.75 | 2.15 2.30 2.25 | 2.50 | V |
| Peak Reverse Recovery Current 反向恢复峰值电流 | $I_F=600A, V_R=600V$ $-di_F/dt=6300A/\mu s(T_{vj}=175^{\circ}C)$ $V_{GE}=-8V$ | $T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$ $T_{vj}=175^{\circ}C$ | I_{RM} | - | 264 320 352 384 | - | A |
| Recovery Charge 反向恢复电荷 | $I_F=600A, V_R=600V$ $-di_F/dt=6300A/\mu s(T_{vj}=175^{\circ}C)$ $V_{GE}=-8V$ | $T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$ $T_{vj}=175^{\circ}C$ | Q_R | - | 19.4 33.8 40.3 50.1 | - | μC |
| Reverse Recovery Energy 反向恢复损耗 | $I_F=600A, V_R=600V$ $-di_F/dt=6300A/\mu s(T_{vj}=175^{\circ}C)$ $V_{GE}=-8V$ | $T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$ $T_{vj}=175^{\circ}C$ | E_{rec} | - | 3.3 12.4 14.1 18.5 | - | mJ |
| Thermal Resistance, Junction to Case 结-外壳热阻 | Per FRD/单个 FRD | | R_{thJC} | - | 0.072 | - | K/W |
| Thermal Resistance, Case to Heatsink 外壳-散热器热阻 | Per FRD/单个 FRD $\lambda_{grease} = 1W(m \cdot K)$ | | R_{thJC} | - | 0.023 | - | K/W |
| Temperature under switching conditions 工作温度 | | | $T_{vj op}$ | -40 | - | 175 | $^{\circ}C$ |

NTC-Thermistor/ NTC-热敏电阻
Characteristic Values / 性能参数

| | | | min. | typ. | max. | |
|-------------------------------|--|--------------|------|------|------|------------|
| Rated Resistance 标称电阻 | $T_{NTC}=25^{\circ}C$ | R_{25} | - | 5 | - | K Ω |
| Deviation of R100 R100 偏移值 | $T_{NTC}=100^{\circ}C, R_{100}=465\Omega$ | $\Delta R/R$ | -7.3 | - | 7.3 | % |
| Power Dissipation 功率耗散 | $T_{NTC}=25^{\circ}C$ | P_{25} | - | - | 10 | mW |
| B-Value B 值 | $R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15K))]$ | $B_{25/50}$ | - | 3380 | - | K |
| | $R_2=R_{25} \exp[B_{25/80}(1/T_2-1/(298.15K))]$ | $B_{25/80}$ | - | 3470 | - | K |
| | $R_2=R_{25} \exp[B_{25/100}(1/T_2-1/(298.15K))]$ | $B_{25/100}$ | - | 3520 | - | K |

Module / 模块

| | | | | | |
|--|----------------------|------------|-------------------|--|----|
| Isolation Test Voltage 绝缘测试电压 | RMS, f=50Hz, t=1min | V_{ISOL} | 3 | | KV |
| Material of Module Baseplate 模块底板材料 | | | Cu | | |
| Internal Isolation 内部绝缘 | | | ZTA | | |
| Creepage Distance 爬电距离 | Terminal to heatsink | | 15.0 | | mm |
| | Terminal to terminal | | 13.0 | | |
| Clearance 电气间隙 | Terminal to heatsink | | 12.5 | | mm |
| | Terminal to terminal | | 10.0 | | |
| Comparative Tracking Index 相对漏电起痕指数 | | CTI | 200 ²⁾ | | |

| | | | min. | typ. | max. | |
|--|---------------------------------------|-------------|------|------|------|-------------|
| Stray Inductance Module 模块杂散电感 | | L_{sCE} | - | 20 | - | nH |
| Module Lead Resistance, Terminals-Chip 模块引脚电阻, 端子-芯片 | $T_C=25^{\circ}C, \text{ Per Switch}$ | R_{CC+EE} | - | 0.8 | - | m Ω |
| Storage Temperature 贮存温度 | | T_{stg} | -40 | - | 125 | $^{\circ}C$ |
| Mounting Torque for Module Mounting 模块安装力矩 | Screw M5 / M5 螺丝 | M | 3.0 | - | 6.0 | Nm |
| Power Terminal Installation Torque 功率端子安装扭矩 | Screw M6 / M6 螺丝 | M | 3.0 | - | 6.0 | Nm |
| Weight 重量 | | G | - | 345 | - | g |

1) Terminal impedance is not included.

不包含端子阻抗。

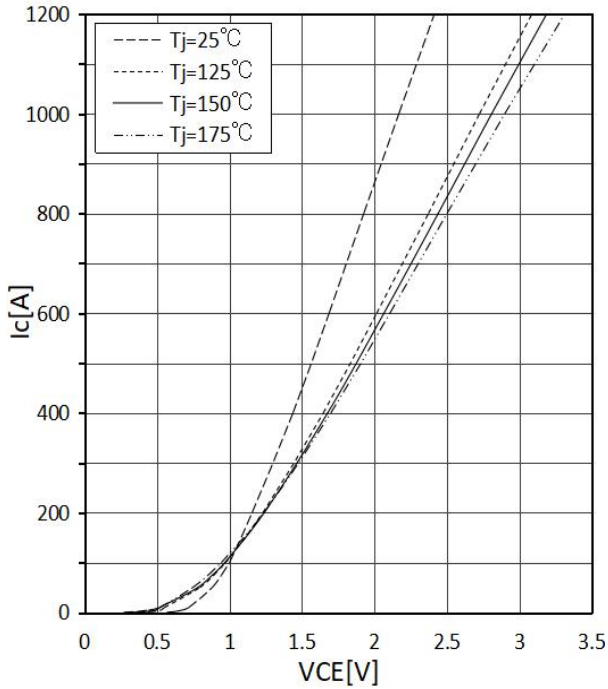
2) CTI is about 200.

CTI 约等于 200。

Circuit Diagram / 曲线图

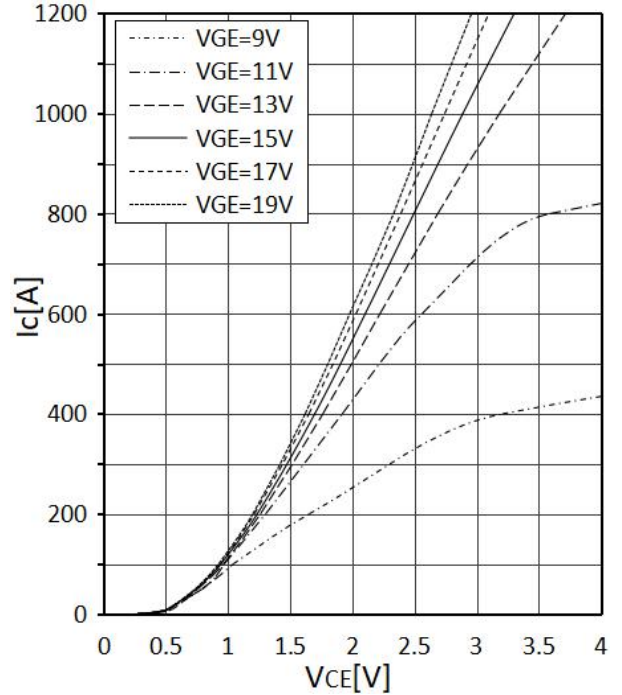
Output characteristic IGBT, Inverter (typical),
输出特性 IGBT, 逆变器 (典型值)

$I_c=f(V_{CE}), V_{GE}=15V$



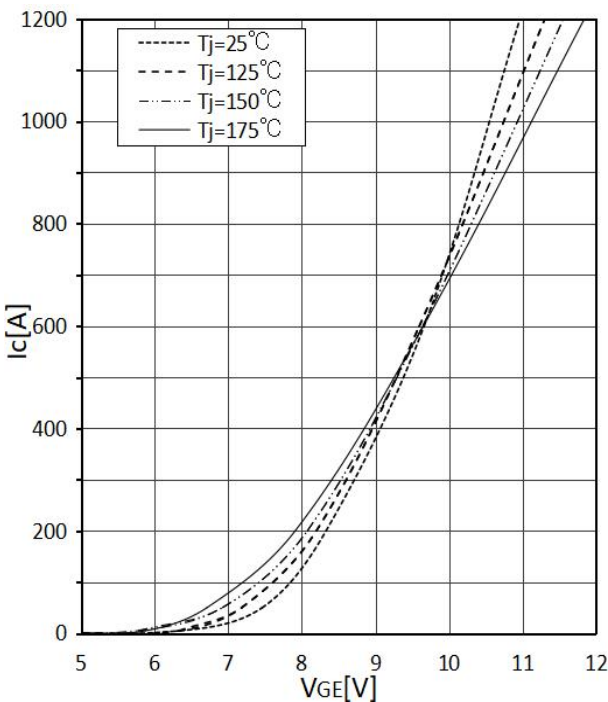
Output characteristic IGBT, Inverter (typical)
输出特性 IGBT, 逆变器 (典型值)

$I_c=f(V_{CE}), T_{vj}=175^{\circ}C$



Transfer characteristic IGBT, Inverter (typical)
传输特性 IGBT, 逆变器 (典型值)

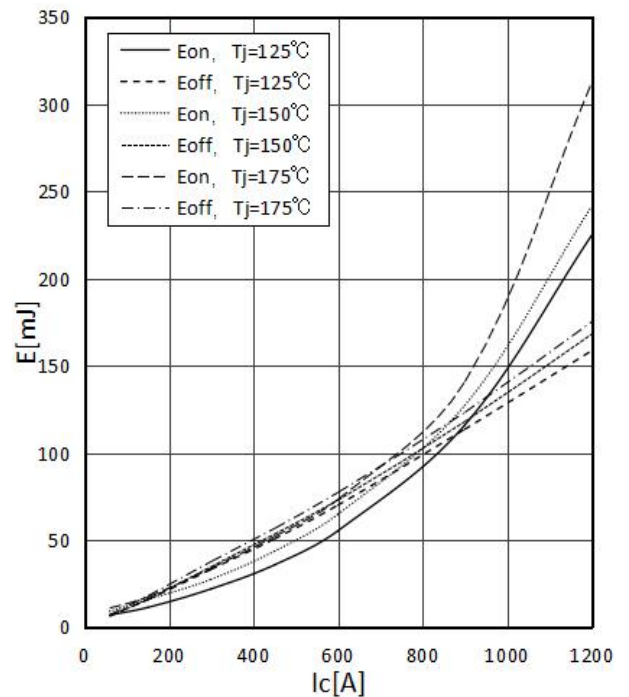
$I_c=f(V_{GE}), V_{CE}=20V$



Switching losses IGBT, Inverter (Typical)
开关损耗 IGBT, 逆变器 (典型值)

$E_{on}=f(I_c), E_{off}=f(I_c)$

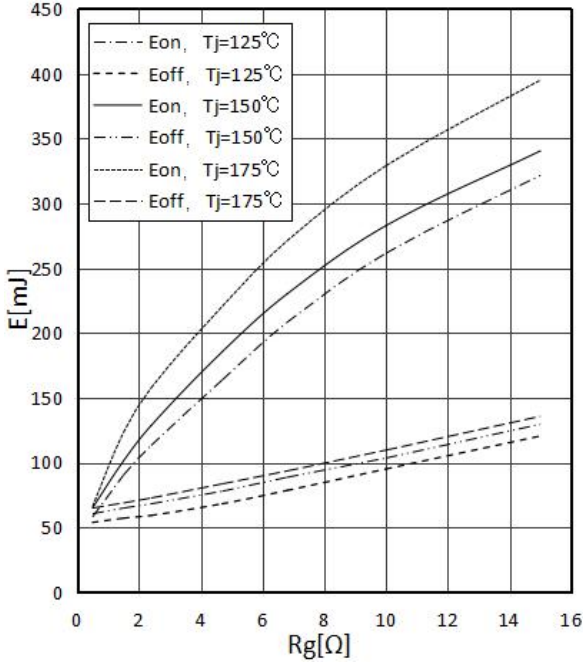
$V_{GE}=+15V/-8V, R_{Gon}=0.5\Omega, R_{Goff}=3.6\Omega, V_{CC}=600V$



Switching losses IGBT, Inverter (Typical)

开关损耗 IGBT, 逆变器 (典型值)

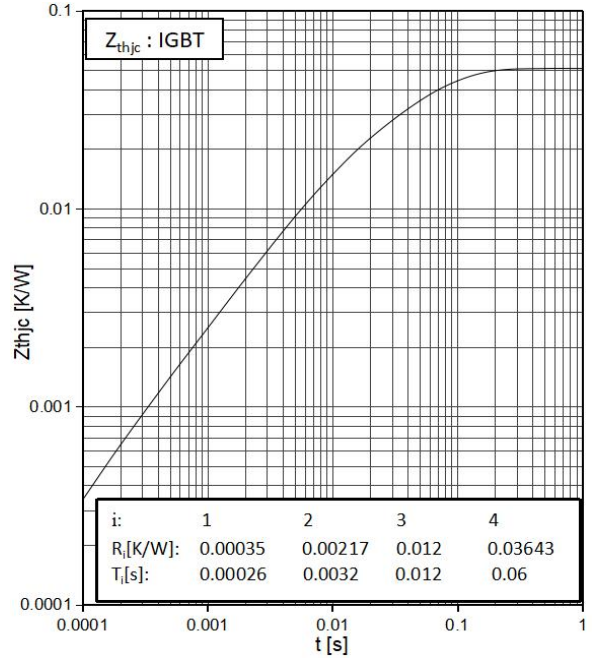
$E_{on}=f(R_G), E_{off}=f(R_G)$
 $V_{GE}=+15V/-8V, I_C=600A, V_{CE}=600V$



Transient thermal impedance IGBT, Inverter

瞬态热阻 IGBT, 逆变器

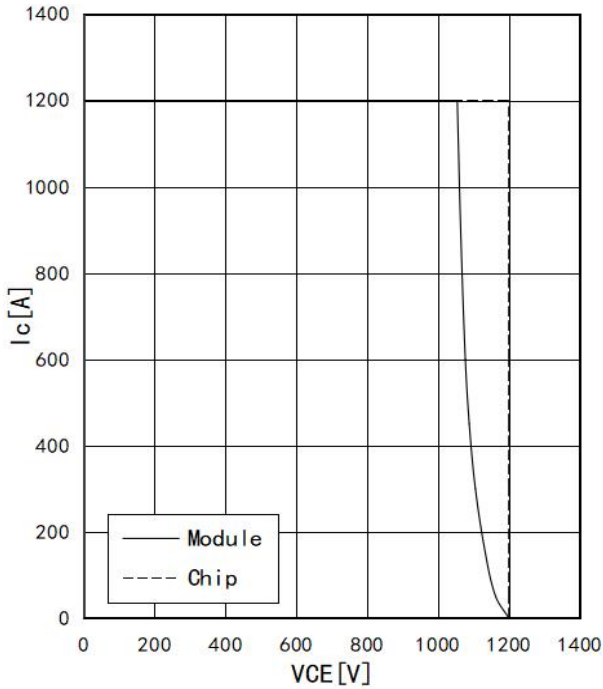
$Z_{thjc}=f(t)$



Reverse bias safe operating area IGBT, Inverter (RBSOA)

反向安全工作区 IGBT, 逆变器 (RBSOA)

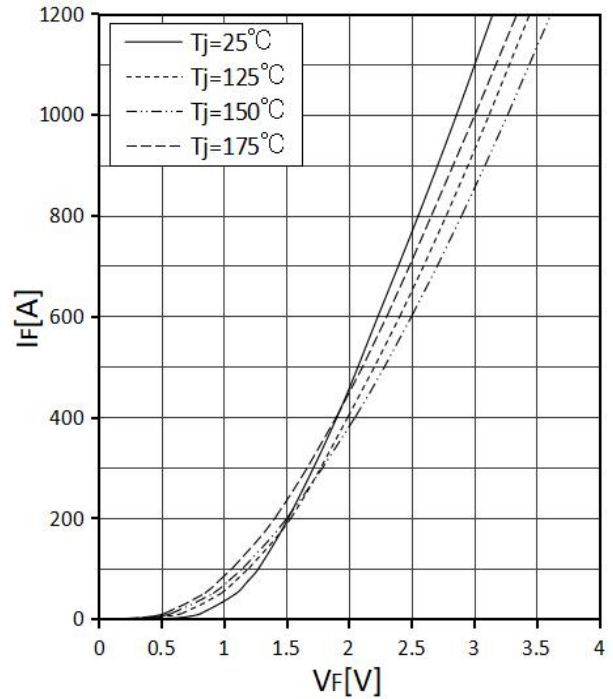
$I_C=f(V_{CE})$
 $V_{GE}=+15V/-8V, R_{Goff}=3.6 \Omega, T_{vj}=175^\circ C$



Forward characteristic of Diode, Inverter (typical)

正向偏压特性 二极管, 逆变器 (典型值)

$I_F=f(V_F)$

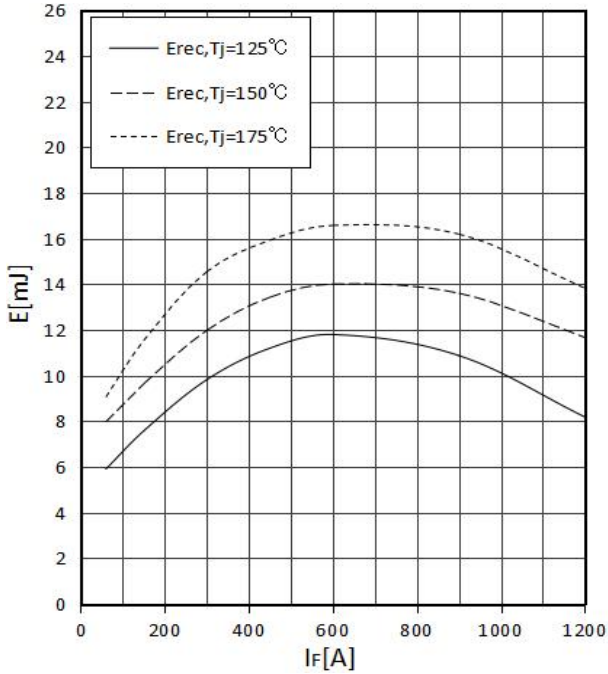


Switching losses Diode, Inverter (typical)

开关损耗 二极管, 逆变器 (典型值)

$E_{rec}=f(I_F)$,

$R_{gon}=0.5\ \Omega, V_{CE}=600V$

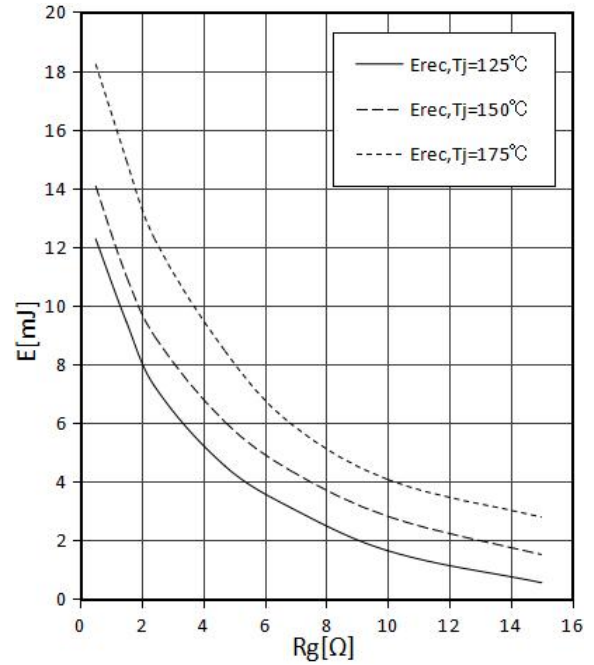


Switching losses Diode, Inverter (typical)

开关损耗 二极管, 逆变器 (典型值)

$E_{rec}=f(R_G)$,

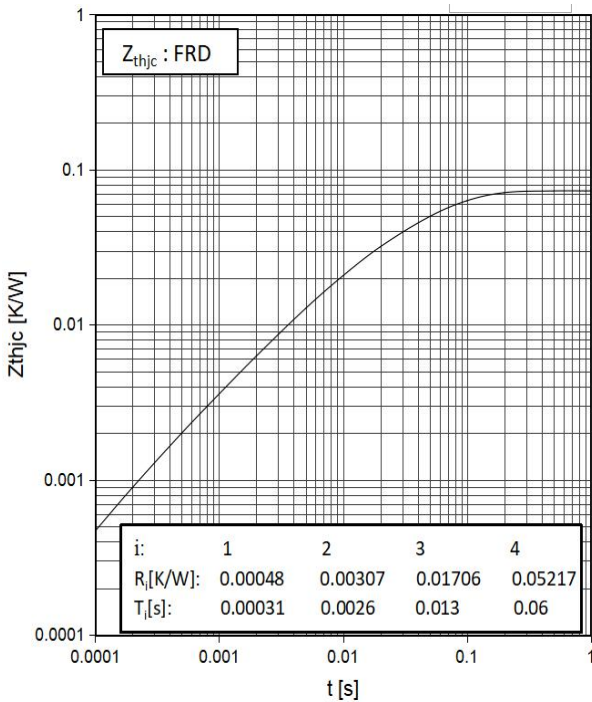
$I_F=600A, V_{CE}=600V$



Transient thermal impedance Diode, Inverter

瞬态热阻抗 二极管, 逆变器

$Z_{thjc}=f(t)$



NTC-Thermistor-temperature characteristic (typical)

负温度系数热敏电阻 温度特性

$R=f(T)$

